

APPROVAL SHEET

			Issued No.:		
DESCRIPTION :		SMD 5032 CRYSTAL			
NOMINAL FREQ.		8.00 MHz			
TAITIEN P/N					
TAITIEN MODEL		5032-8.00-12-10-102PB			
REVISION		1			
DATE	:	06/19/2017			
QA		Checked	Prepared		
CUSTOMER	:				
CUSTOMER P/N					
CUSTOWIER P/N	: -				
	Cuci	to moon Ciamot			
Customer Signature					
Approved:					
Date:					



REVISION HISTORY

Rev.	Revised Page	Revision Content	Date	Ref. No.	Reviser
01	N/A	InitialReleased	06/29/2016	N/A	YU PING MA



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■ ELECTRICAL SPECIFICATIONS

	Parameter	Min.	Тур.	Max.	Units	Test Condition
1-1	Nominal Frequency		8.00		MHz	
1-2	Frequency Tolerance.	-10		+10	ppm	at 25°C+/-2°C
1-3	Operating Temperature range	-20		+75	°C	
1-4	Storage Temperature range	-40		+85	°C	
1-5	Temperature Characteristics	-10		+10	ppm	-30°C to +75°C
1-6	Nominal Load Capacitance		12		pF	
1-7	Series Resistance			100	Ω	
1-8	Shunt Capacitance			7	pF	
1-9	Motion Capacitance				fF	
1-10	Motion Inductance				mH	
1-11	Q factor				K	
1-12	Spurious Response				dB	
1-13	Frequency Pull ability				ppm/pF	
1-14	C0/C1 Ratio					
1-15	Aging	-3		+3	ppm/year	
1-16	Insulation Resistance	500	MΩ Min. @ DC1	00V		
1-17	Nominal Drive Level		10		μ w	into 10Ω
1-18	Dependency Condition				μ w	
1 10	Drive Level Dependency				Ω	
1-19	Resistance Max. Minus Min.				77	
1-20	Drive Level Dependency				nnm	
1-20	Frequency Max. Minus Min.				ppm	
1-21	Drive Level Dependency				Ω	
1-21	Resistance Max.				\$2	



■ CUSTOMER SPECIAL REQUIREMENT

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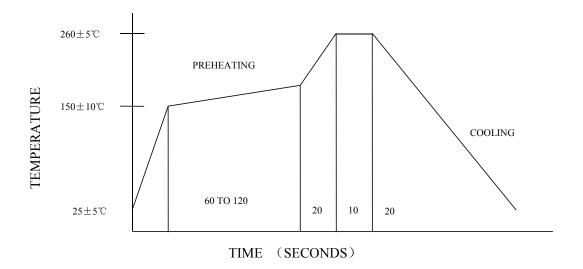
■ ENVIRONMENTAL

	Parameter	Reference Std.	Test Condition
3-1 Vibration		MIL-STD-883 2007 Condition A	10~2000Hz, 1.52mm, 20g, each
	VIDIALION TEST	JESD22-B103 Condition 1	axis for 4 hrs
3-2 Thermal Shock	Thormal Chook	MIL-STD-883 1010 Condition B	-55°ℂ, 125°ℂ; soak time is 10
	JESD22-A104 Condition B	mins, with total 200 cycles	
3-3 N	Mechanical Shock	MIL-STD-883 2002 Condition B	1500G, half-sine, 0.5ms, each
		JESD22-B104 Condition B	axis for 3 times.



■ RECOMMENDED IR REFLOW PROFILE

> IR REFLOW PROFILE OF CERAMIC SMD PRODUCTS FOR Pb FREE PROCESS

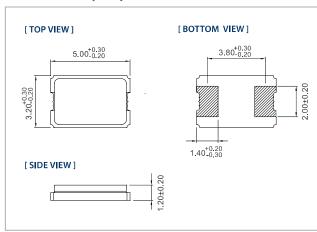




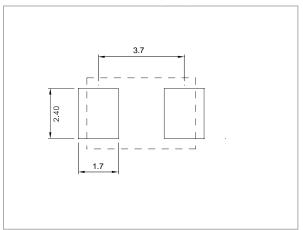
■ PRODUCT DIMENSIONS

DIMENSIONS

DIMENSION (mm)

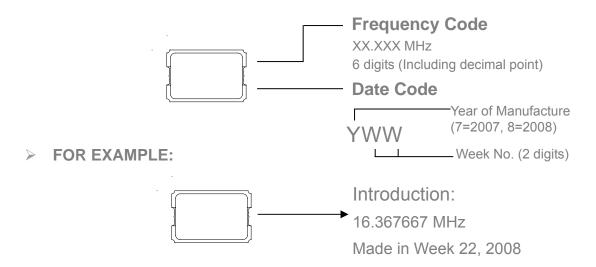


SOLDER PAD LAYOUT (mm)



■ PRODUCT IDENTIFICATION (MARKING)

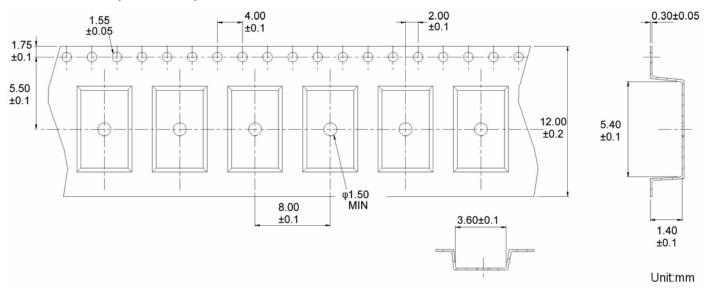
> PROCEDURE: LASER



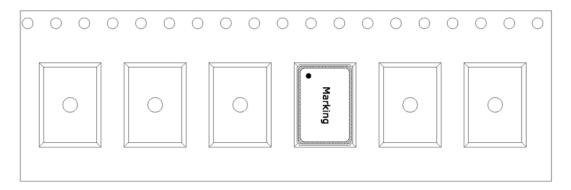


■ PACKAGE INFORMATION

> TAPE (CARRIER) DIMENSIONS



> THE DIRECTION OF PACKING



> REEL DIMENSIONS

